

ROITHNER LASERTECHNIK GMbH

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- 550 nm, 100 mW
- InGaAs chip, 1000 x 1000 μm
- **PA9T SMD package**
- Beam Angle: ± 65°



Description



SMB1N-550H is a surface mount InGaN based high power green LED, with a typical peak wavelength of 550 nm and optical output power of 100 mW @ 350 mA. It comes in SMD package (PA9T) with silver plated soldering pads (lead free solderable), copper heat sink, and silicone resin molded flat window.

Maximum Ratings*

Parameter	Cumbal	Va	I Imit		
Parameter	Symbol	Min.	Max.	Unit	
Power Dissipation	PD		1200	mW	
Forward Current	l _F		350	mA	
Pulse Forward Current **	I FP		500	mA	
Reverse Voltage	UF		5	V	
Thermal Resistance	RTHJA		10	K/W	
Junction Temperature	T_J		120	°C	
Operating Temperature	TCASE	- 40	+ 100	°C	
Storage Temperature	T _{STG}	- 40	+ 100	°C	
Lead Solder Temperature (t _{max} . 5s)	T _{SLD}		+ 250	°C	

^{*}Operating close to or exceeding these parameters may damage the device

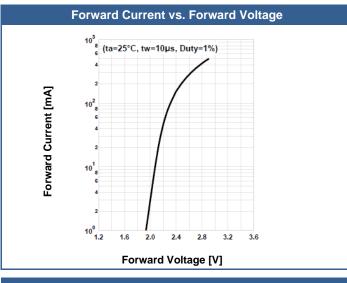
Electro-Optical Characteristics (TCASE = 25°C)

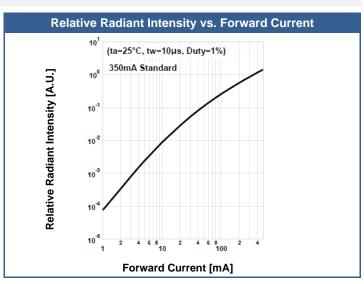
Parameter	Symbol	Conditions	Min.	Values Typ.	Max.	Unit
Peak Wavelength	λ_P	I _F =350 mA	540		560	nm
Half Width	λ_{Δ}	I _F =350 mA		35		nm
Forward Voltage	VF	I _F =350 mA		2.7	3.4	V
	VFP	I _{FP} =500 mA		2.9		
Total Radiated Power	Po	$I_F=350 \text{ mA}$	70	100		mW
		I _{FP} =500 mA		140		
Radiant Intensity	I _E	I _F =350 mA		33		mW/sr
		I _{FP} =500 mA		46		
Viewing Angle	2θ1/2	I _F =100 mA		130		deg.
Rise Time	t r	I _F =350 mA		100		ns
Fall Time	t f	I _F =350 mA		30		ns

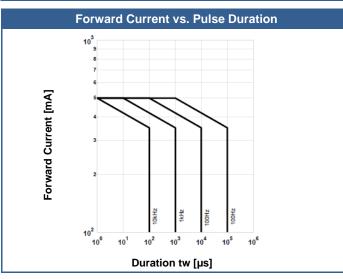
^{*} duty cycle = 1 %, pulse width = 10 μ s

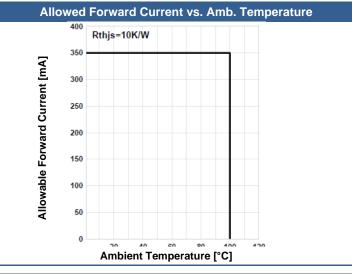
^{**} duty cycle = 1 %, pulse width = 10 μ s

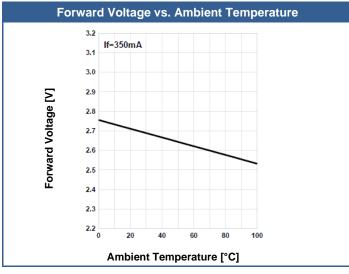
Typical Performance Curves

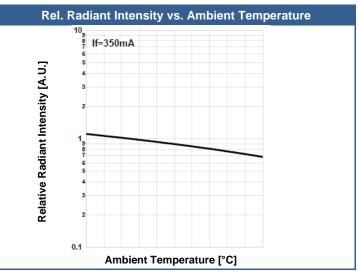




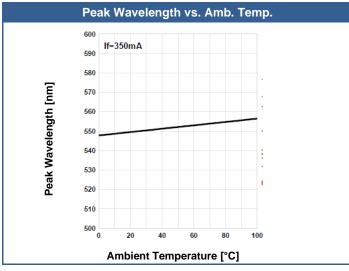


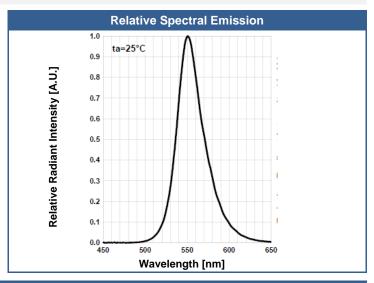


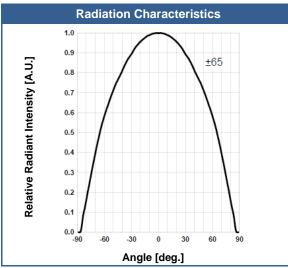


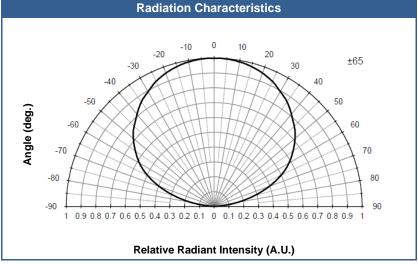


Typical Performance Curves

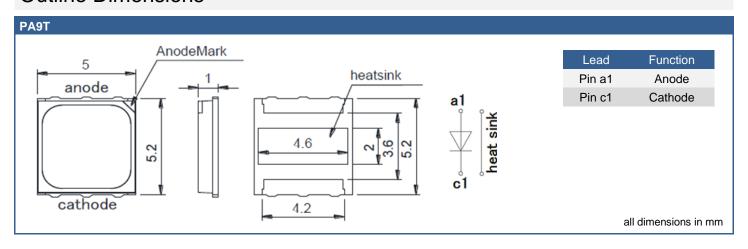








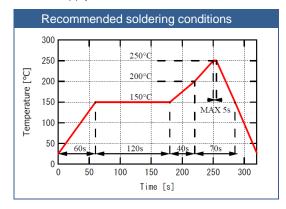
Outline Dimensions

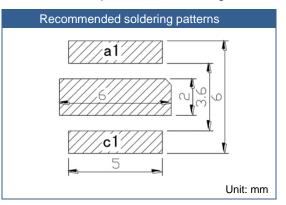


General Notes

Soldering

- · Do avoid overheating of the LED
- Do avoid electrostatic discharge (ESD)
- Do avoid mechanical stress, shock, and vibration
- Do only use non-corrosive flux
- Do not apply current to the LED until it has cooled down to room temperature after soldering





Cleaning

- . Cleaning with isopropyl alcohol, propanol, or ethyl alcohol is recommended
- DO NOT USE acetone, chloroseen, trichloroethylene, or MKS
- DO NOT USE ultrasonic cleaners

Static Electricity

- · LEDs are sensitive to electrostatic discharge (ESD).
- Precautions against ESD must be taken when handling or operating these LEDs
- Surge voltage or electrostatic discharge can result in complete failure of the LED.

Radiation

- During operation these LEDs do emit light, which could be hazardous to skin and eyes, and may cause cancer.
- · Do avoid exposure to the emitted light. Protective glasses if needed
- It is further advised to attach a warning label on products/systems.

Operation

- · Do only operate LEDs with a current source.
- Running these LEDs from a voltage source will result in complete failure of the device.
- Current of a LED is an exponential function of the voltage across it. Usage of current regulated drive circuits is mandatory.

Storage

- The maximum shelf life of LEDs in the originally sealed aluminum bag is 12 months.
- Before opening the aluminum bag, please store it at <30 °C, <60 % RH.
- After opening the aluminum bag, please solder the LEDs within 72 hours (floor life) at 5 − 30 °C, <50 % RH.
- Put any unused, remaining LEDs and silica gel back in the same aluminum bag and then vacuum-seal the bag.
- It is recommended to keep the re-sealed bag in a desiccator at <30%RH.

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